OBSOLETE - No Longer Available SN5486, SN54LS86A, SN54S86 SN7486, SN74LS86A, SN74S86 QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES

SDLS124 - DECEMBER 1972 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

	TYPICAL AVERAGE	TYPICAL
TYPE	PROPAGATION	TOTAL POWER
	DELAY TIME	DISSIPATION
'86	14 ns	150 mW
'LS86A	10 ns	30.5 mW
'S86	7 ns	250 mW

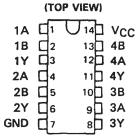
description

These devices contain four independent 2-input Exclusive-OR gates. They perform the Boolean functions $Y = A \oplus B = \overline{A}B + A\overline{B}$ in positive logic.

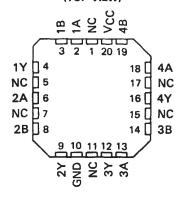
A common application is as a true/complement element. If one of the inputs is low, the other input will be reproduced in true form at the output. If one of the inputs is high, the signal on the other input will be reproduced inverted at the output.

The SN5486, 54LS86A, and the SN54S86 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7486, SN74LS86A, and the SN74S86 are characterized for operation from 0°C to 70°C.

SN5486, SN54LS86A, SN54S86 . . . J OR W PACKAGE SN7486 . . . N PACKAGE SN74LS86A, SN74S86 . . . D OR N PACKAGE



SN54LS86A, SN54S86 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

EXCLUSIVE-OR

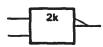
These are five equivalent Exclusive-OR symbols valid for an '86 or 'LS86A gate in positive logic; negation may be shown at any two ports.

LOGIC IDENTITY ELEMENT



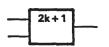
The output is active (low) if all inputs stand at the same logic level (i.e., A = B).

EVEN-PARITY



The output is active (low) if an even number of inputs (i.e., 0 or 2) are active.

ODD-PARITY ELEMENT



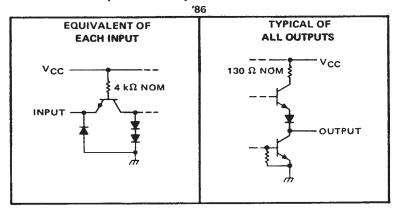
The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

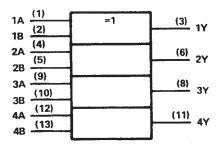


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schematics of inputs and outputs



logic symbol†



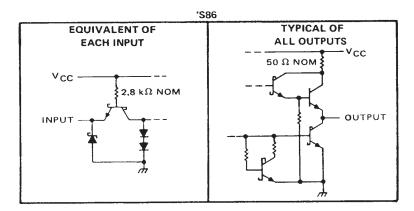
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

LS86A **EQUIVALENT OF EACH INPUT** TYPICAL OF ALL OUTPUTS -Vcc 150 Ω Vcc -NOM 12.5 kΩ NOM INPUT -OUTPUT

FUNCTION TABLE

INP	UTS	OUTPUT
Α	В	Υ
L	L	L
L	Н	н
Н	L	н
Н	н	L

H = high level, L = low level



OBSOLETE - No Longer Available SN5486, SN54LS86A, SN54S86 SN7486, SN74LS86A, SN74S86

QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)					٠					 	7 V
Input voltage										 	5.5 V
Operating free-air temperature range: SI											
	N7486										
Storage temperature range											

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5486	6		SN7486	3	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			-800	μΑ
Low-level output current, IOL			16			16	mA
Operating free-air temperature, TA	55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETER	TEST CONDITIONS†	1	SN5486	3		SN7486	5	UNIT
	PARAMETER	TEST CONDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
ViH	High-level input voltage		2			2			V
VIL	Low-level input voltage				8.0			8.0	٧
VIK	Input clamp voltage	V _{CC} = MIN, I ₁ = -8 mA	1		-1.5			-1.5	V
	Uish lavel automated	VCC = MIN, VIH = 2 V,	2.4	3.4		2.4	3.4		v
VOH	High-level output voltage	$V_{1L} = 0.8 \text{ V}, i_{OH} = -800 \mu\text{A}$	2.4	3.4		2.4	3.4		"
1/	Law lavel output valtage	V _{CC} = MIN, V _{IH} = 2 V		0.2	0.4		0.2	0.4	V
VOL	Low-level output voltage	V _{1L} = 0.8 V, 1 _{OL} = 16 mA	1	0,2	0.4		0.2	0.4	
1	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
11H	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V			40			40	μΑ
IIL	Low-level input current	V _{CC} = MAX, V _I = 0.4 V			-1.6			-1.6	mA
los	Short-circuit output current§	V _{CC} = MAX	20		-55	-18		-55	mA
1CC	Supply current	V _{CC} = MAX, See Note 2		30	43		30	50	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST COM	IDITIONS	MIN	TYP	MAX	UNIT
tPLH	A or B	Oahar innut law	C. = 15 pF		15	23	ns
t _{PHL}	AUB	Other input low	C _L = 15 pF, R _L = 400 Ω,		11	17	
tPLH	A or B	Oshan innus bish	See Note 3		18	30	ns
tPHL.	A 01 B	Other input high	See Note 5		13	22	

¶tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§]Not more than one output should be shorted at a time.

NOTE 2: ICC is measured with the inputs grounded and the outputs open.

SN5486, SN54LS86A, SN54S86 SN7486, SN74LS86A, SN74S86 QUADRUR E 2 INDUT EVENT QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES

SDLS124 – DECEMBER 1972 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)					 								7 V
Input voltage					 								7 V
Operating free-air temperature range: SN54LS86A	١.				 						-55	°C to	125°C
SN74LS86A	١.				 							0°C 1	o 70°C
Storage temperature range													

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	S	N54LS	36A	SI	N74LS8	6A	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-400			-400	μА
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			NO ITIONS CT	SI	154LS8	6A	SI	174LS8	6A	UNIT
	PARAMETER	TEST CO	NDITIONS [†]	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			2			\ \ \ _
VIL	Low-level input voltage					0.7			0.8	V
VIK	Input clamp voltage	VCC = MIN,	I ₁ = -18 mA			-1.5			-1.5	٧
VOH	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max	V _{1H} = 2 V, , I _{OH} = -400 μA	2.5	3.4		2.7	3.4		٧
Vai	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	\ \ \
VOL.	Low-level output vortage	VIL = VILmax	IOL = 8 mA					0.35	0.5	
11	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V			0.2			0.2	mA
ЧН	High-level input current	V _{CC} = MAX,	V _I = 2.7 V			40			40	μА
IIL	Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V			-0.8			-0.8	mA
los	Short-circuit output current §	V _{CC} = MAX		- 20		- 100	- 20		- 100	mA
Icc	Supply current	V _{CC} = MAX,	See Note 2		6.1	10		6.1	10	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

NOTE 2: I_{CC} is measured with the inputs grounded and the outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST CON	IDITIONS	MIN	TYP	MAX	UNIT
tPLH	A or B	Out as in suct love	C 15 pE		12	23	ns
t _{PHL}	Aorb	Other input low	CL = 15 pF, RL = 2 kΩ,		10	17	
tpLH	A or B	Other input high	See Note 3		20	30	ns
t _{PHL}	A 01 B	Other input night	366 NOTE 3		13	22	

[¶]tpLH = propagation delay time, low-to-high-level output



Not more than one output should be shorted at a time.

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

OBSOLETE - No Longer Available SN5486, SN54LS86A, SN54S86 SN7486, SN74LS86A, SN74S86 **QUADRUPLE 2-INPUT EXCLUSIVE-OR GATES**

SDLS124 - DECEMBER 1972 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .									 					7 \	1
Input voltage									 					5.5 \	1
Operating free-air temperature range:	SN54S86		 •			•			 		-ŧ	55°	C to	125°0	;
	SN74S86								 			0	°C 1	o 70°0)
Storage temperature range															

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S8	6		SN74S8	6	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	ONI
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			1			-1	mA
Low-level output current, IOL			20			20	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		Teet constitutionst		SN54S8	6	SN74S86			UNIT
	PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	MIN	TYP [‡]	MAX	10.4.1
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	٧
VIK	Input clamp voltage	V _{CC} = MIN, I ₁ = -18 mA			-1.2		-	-1.2	٧
v _{OH}	High-level output voltage	V _{CC} = MIN, V _{1H} = 2 V, V _{1L} = 0.8 V, I _{OH} = -1 mA	2.5	3.4		2.7	3.4		٧
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V V _{IL} = 0.8 V, I _{OL} = 20 mA			0.5			0.5	V
T ₁	Input current at maximum input voltage	V _{CC} = MAX, V _i = 5.5 V			1			1	mA
Чн	High-level input current	V _{CC} = MAX, V _I = 2.7 V			50			50	μА
1 ₁ L	Low-level input current	V _{CC} = MAX, V _I = 0.5 V	1		-2			-2	mA
los	Short-circuit output current§	V _{CC} = MAX	-40		-100	-40		-100	mA
Icc	Supply current	V _{CC} = MAX, See Note 2		50	75		50	75	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

NOTE 2: ICC is measured with the inputs grounded and the outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER¶	FROM (INPUT)	TEST COM	IDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	A or P	Other input low	0 - 15 - 5		7	10.5	ns
[†] PHL	A or B	Other input low	C _L = 15 pF,		6.5	10	
tpLH	A or B	Other input high	$R_L = 280 \Omega$, See Note 3		7	10.5	ns
tPHL	AOIB	Other input high	See Note 3		6.5	10	

TtpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.





6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07501BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BCA	Sample
JM38510/07501BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BDA	Samples
JM38510/07501BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BDA	Sample
JM38510/30502B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30502B2A	Sample
JM38510/30502B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30502B2A	Samples
JM38510/30502BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BCA	Samples
JM38510/30502BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BCA	Samples
JM38510/30502BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BDA	Sample
JM38510/30502BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BDA	Samples
M38510/07501BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BCA	Samples
M38510/07501BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BCA	Samples
M38510/07501BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BDA	Samples
M38510/07501BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 07501BDA	Samples
M38510/30502B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30502B2A	Samples
M38510/30502B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30502B2A	Samples
M38510/30502BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BCA	Sample
M38510/30502BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BCA	Samples



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Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Sample
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
M38510/30502BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BDA	Sample
M38510/30502BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510/ 30502BDA	Sample
SN54LS86AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS86AJ	Sample
SN54LS86AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS86AJ	Sample
SN54S86J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54S86J	Sample
SN54S86J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54S86J	Sample
SN74LS86AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sample
SN74LS86AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sampl
SN74LS86ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sampl
SN74LS86ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sampl
SN74LS86ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sampl
SN74LS86ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS86A	Sampl
SN74LS86AN	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Sampl
SN74LS86AN	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Sampl
SN74LS86ANE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Sampl
SN74LS86ANE4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS86AN	Sampl
SN74LS86ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS86A	Samp
SN74LS86ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS86A	Samp
SNJ54LS86AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS	Samp



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PACKAGE OPTION ADDENDUM

6-Feb-2020

Orderable Device	Status	Package Type	-		Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
										86AFK	
SNJ54LS86AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 86AFK	Samples
SNJ54LS86AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54LS86AJ	Samples
SNJ54LS86AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54LS86AJ	Samples
SNJ54LS86AW	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54LS86AW	Samples
SNJ54LS86AW	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54LS86AW	Samples
SNJ54S86J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S86J	Samples
SNJ54S86J	ACTIVE	CDIP	J	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54S86J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

6-Feb-2020

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS86A, SN74LS86A:

Catalog: SN74LS86A

Military: SN54LS86A

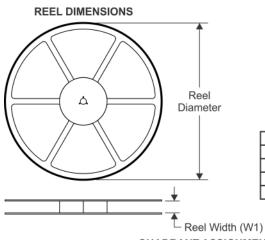
NOTE: Qualified Version Definitions:

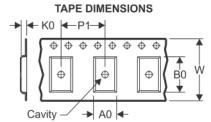
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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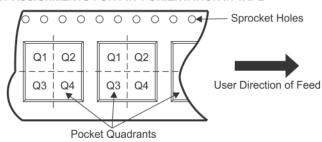
TAPE AND REEL INFORMATION





		Dimension designed to accommodate the component width
ı		Dimension designed to accommodate the component length
ı	K0	Dimension designed to accommodate the component thickness
ı	W	Overall width of the carrier tape
-	P1	Pitch between successive cavity centers

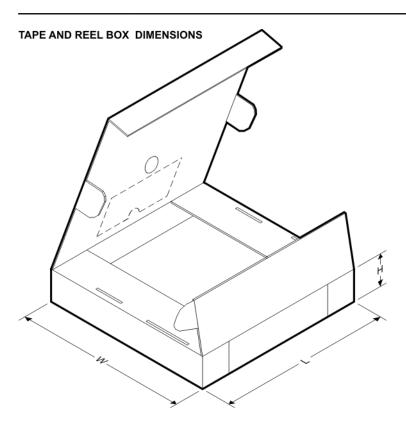
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS86ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

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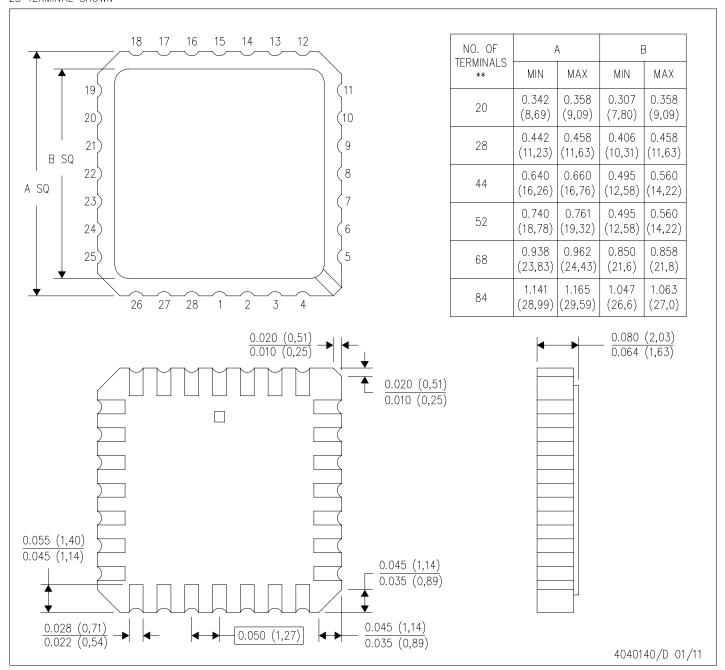
*All dimensions are nominal

ĺ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
	SN74LS86ADR	SOIC	D	14	2500	367.0	367.0	38.0	

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004

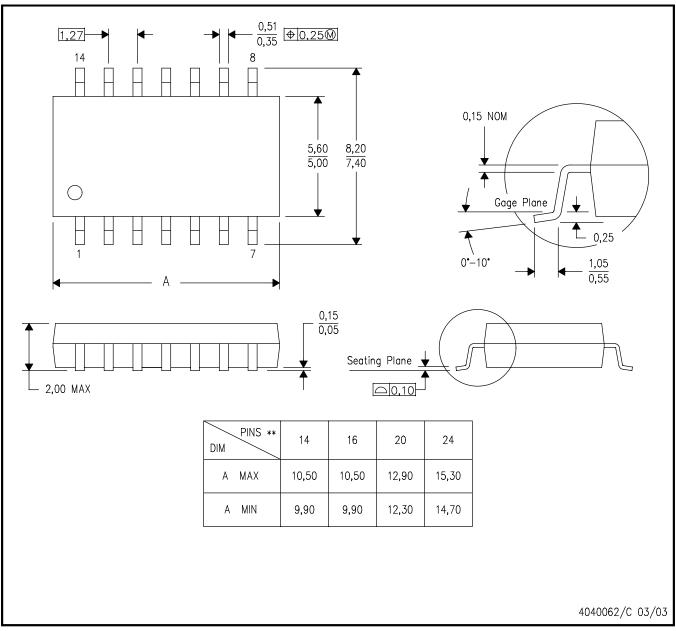


MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE

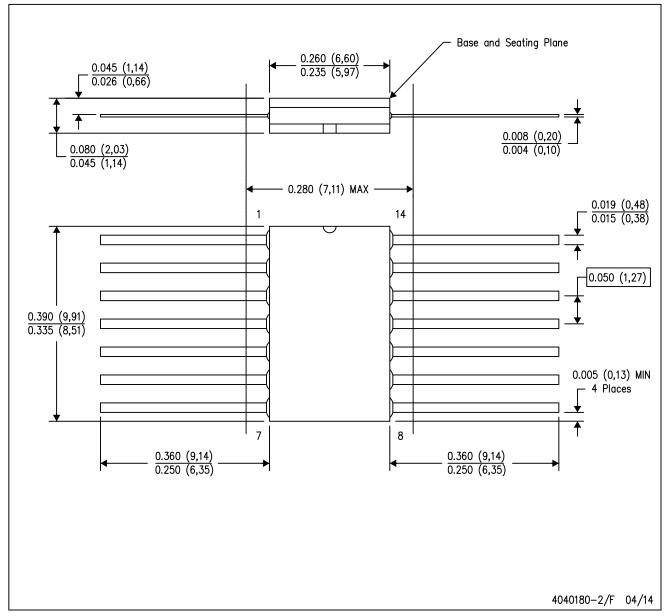


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

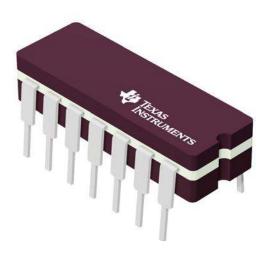
CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



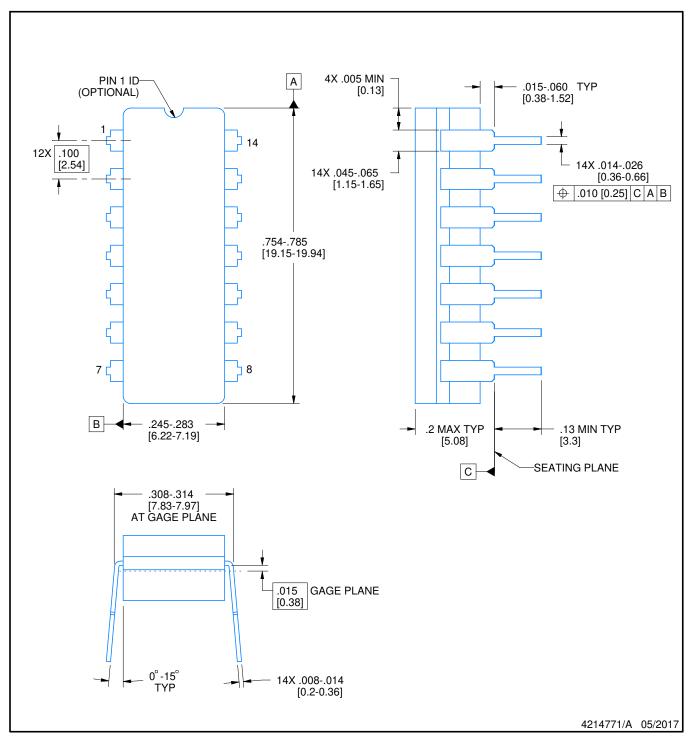
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





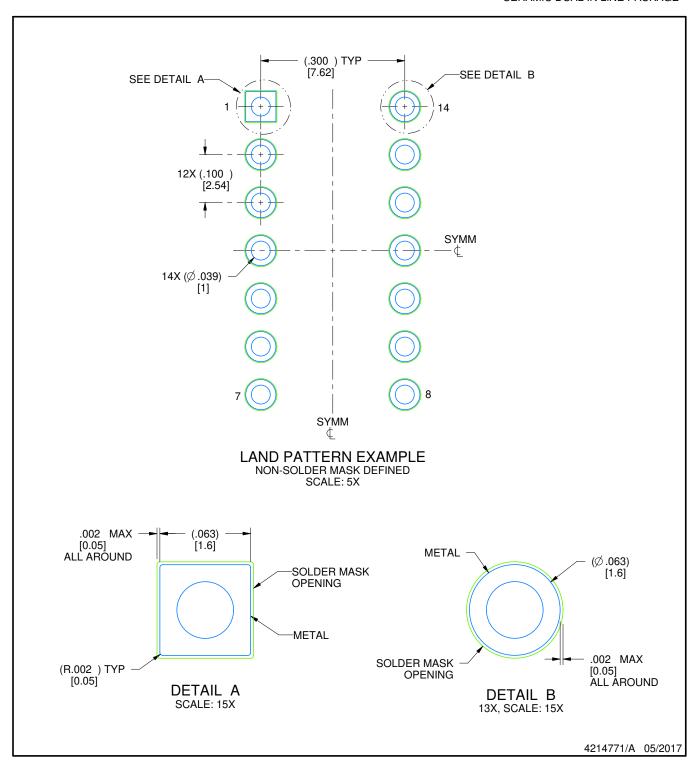
CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a certain is using glass int.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

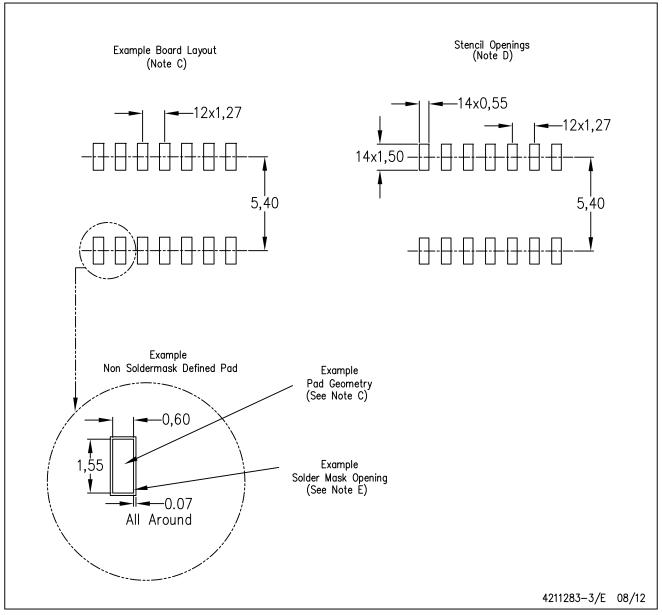


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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